CLASSIFICATION	PRODUCT SPECIF	ICATION	No.	REV.
SUBJECT CLASS	2 BLUETOOTH LOW	ENERGY	DS-17xx-2400-1 PAGE	02 1.7 1 of 35
SUBJECT S CUSTOMER'S CODE	INGLE MODE MODU		_	
PAN172x / PAN171x	ENW89820AxKF		DATE	28.01.2013
Spe	cification	for Prod	luction	
Applicant / Manufacturer Hardware	Panasonic Inc Zeppelinstras 21337 Lünebu Germany		ırope GmbH	
Applicant / Manufacturer Software	Please refer to Software Vers	o chapter 26 / 26.1 sions	Information rega	rding
Software Version	Please refer to Software Vers	o chapter 26 / 26.1 sions	Information rega	rding
Bluetooth QDL ID		ign Listing (QDL) I Sub-System Listin		eries.
By purchase of any of p document's validity and recommendations. Pana notification.	declares their agree	ment and unders	standing of its co	ontents and
Power Electronics R Wireless Conne Panasonic Industrial Devic	ectivity	APPROVED genehmigt	CHECKED geprüft	DESIGNED erstellt

1. So 2. Di 3. Di 4. Ko 5. Bl	SIN SCODE PAN171x COF CONTENTS Cope of this Docume ifference PAN1720 / ifference PAN172x / ey Features luetooth Low Energy pplications for the M	ALUETOOTH LOW ENERGY GLE MODE MODULE PANASONIC'S CODE ENW89820AxKF / ENW89835AxKF		 .4
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2. Di 3. Di 4. Ke 5. Bl	ifference PAN1720 / ifference PAN172x / ey Features luetooth Low Energy pplications for the M	PAN1721 PAN171x		
3. Di 4. Ke 5. Bl	ifference PAN172x / ey Features luetooth Low Energy pplications for the M	PAN171x		.4
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		nal Layout		
-	•	am		
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		rements and Operation		
		um Ratings		
		Operating Conditions		
		nt Consumption		
		ance		
		both Characteristics		
		both Characteristics		
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		e-Time Profile (for reflow soldering)		
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	CUMENT n applies to Panasonic's, Class 2, Blueto 0 (CC2540 from Texas Instruments) and			ule,
Instruments). 2. DIFFERENCE PAN17	·			
Both the PAN1720 and I	PAN1721 are refered to as the PAN172x	in this document.		
communication interface PAN1720. Compared to	npatible with the PAN1720, with the exce on the PAN1720 and I2C is the hardwar the PAN1720, the PAN1721 provides lov interface found on the PAN1720, and pro	e communication i wer RF current cor	interface on the sumption. The PA	
Additional details , which Instruments.	have an impact on the module can be fo	ound in the datash	eets from Texas	
CC2540 from Texas Inst	truments			
CC2541 from Texas Inst	truments			
Both ICs the CC2540 as	well as the CC2541 come with an intern	al 256 KB flash me	emory.	
3. DIFFERENCE PAN17	2X / PAN171X			
The PAN171x are the no	on antenna version where the PAN172x a	are the versions wi	th antenna.	
4. KEY FEATURES				
 Surface mount Up to 4.0 dBm CC2541 has type High sensitivity 	Energy Single Mode 4.0 type 15.6 x 8.7 x 1.8 mm ³ Tx power (typical) with transmit powe pically 0dBm Tx power (-94 dBm typ.) ent's CC2540/CC2541 Single Chip Bl		łe	
 High performant No external correction Fast Connection Internal crystal Internal 32khz or 	nce low power 8051 Microcontroller c mponents needed n Setup oscillator (26MHz) crystal oscillator for Sleep Timer			
 Two powerful L USB or I2C inte Powerful five cl 	erface			
¹ Bluetooth is a registered	d trademark of the Bluetooth Special Inter	rest Group.		

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Latest Profiles included e.g. Battery Monitor and Temperature sensor Integrated shielding to resist EMI •

•

Manufactured in conformance with RoHS •

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5. BLUETOOTH LOW ENERGY

Bluetooth Low Energy (BLE), part of Bluetooth Ver. 4.0, specifies two types of implementation: Single mode and dual mode. Single mode devices implement the low energy specification and consume just a fraction of the power of classic Bluetooth, allowing the short-range wireless standard to extend to coin cell battery applications for the first time. Dual mode devices combine low energy with the power of classic Bluetooth and are likely to become a de facto feature in almost all new Bluetooth enabled cellular phones and computers.

Single mode Bluetooth 4.0 Low Energy is not backwards compatible with previous Bluetooth standards. Dual mode Bluetooth 4.0 Low Energy is backwards compatible and well suited for gateway applications, but is not practical for low power devices.



6. APPLICATIONS FOR THE MODULE

All Embedded Wireless Applications

- Access Points
- Industrial Control
- Medical
- Scanners
- Wireless Sensors
- Low Power

- Proximity
- Smart Phone
- Access Points
- Temperature
- Wellness
- Sports

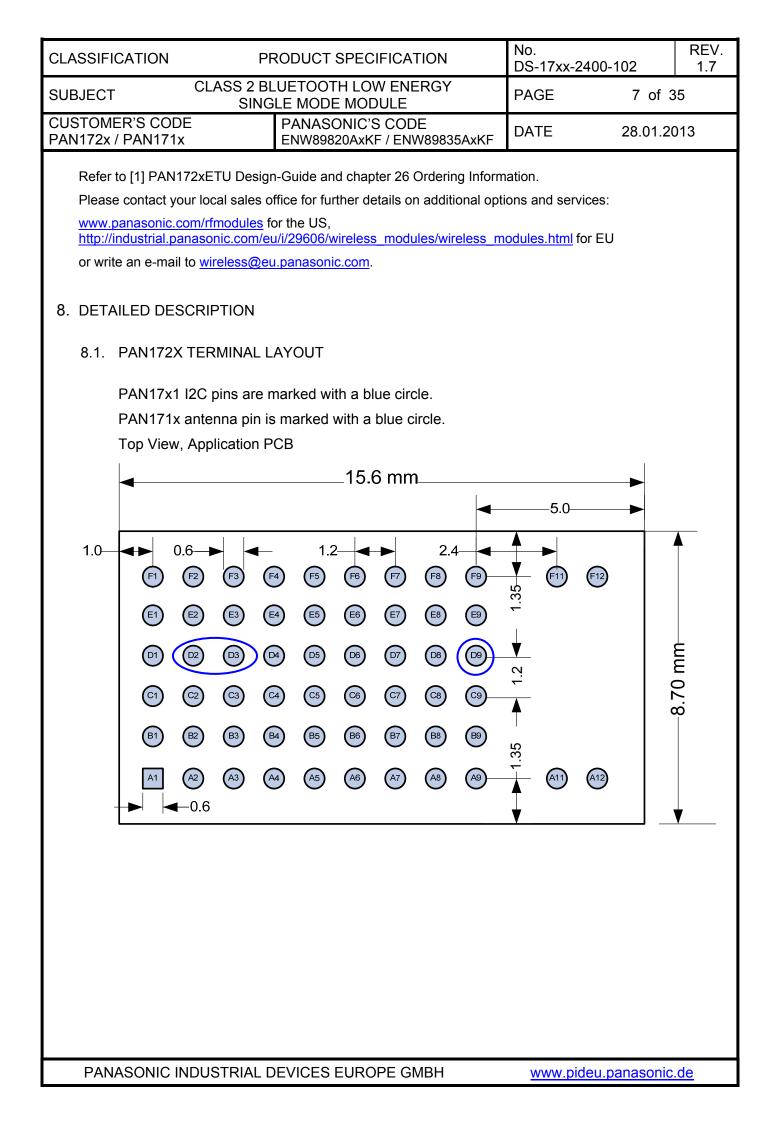
7. DESCRIPTION FOR THE MODULE

The PAN172x is a short-range, Class 2, BLE single mode module for implementing Bluetooth functionality into various electronic devices. A block diagram can be found in chapter 10.

The PAN172x is a cost-effective, low-power, true system-on-chip (SoC) for Bluetooth low energy applications. It enables robust BLE master or slave nodes to be built with very low total bill-of-material costs. The PAN172x combines an excellent RF transceiver with an industry-standard enhanced 8051 MCU, in-system programmable flash memory, 8-KB RAM, and many other powerful supporting features and peripherals. The PAN172x is suitable for systems where very low power consumption is required. Very low-power sleep modes are available. Short transition times between operating modes further enable low power consumption.

Panasonic offers Bluetooth low energy protocol stacks and applications from Texas Instruments and BlueRadios. The Bluetooth low energy protocol stack from Texas Instruments, is a flexible and cost-effective single-mode Bluetooth low energy solution.

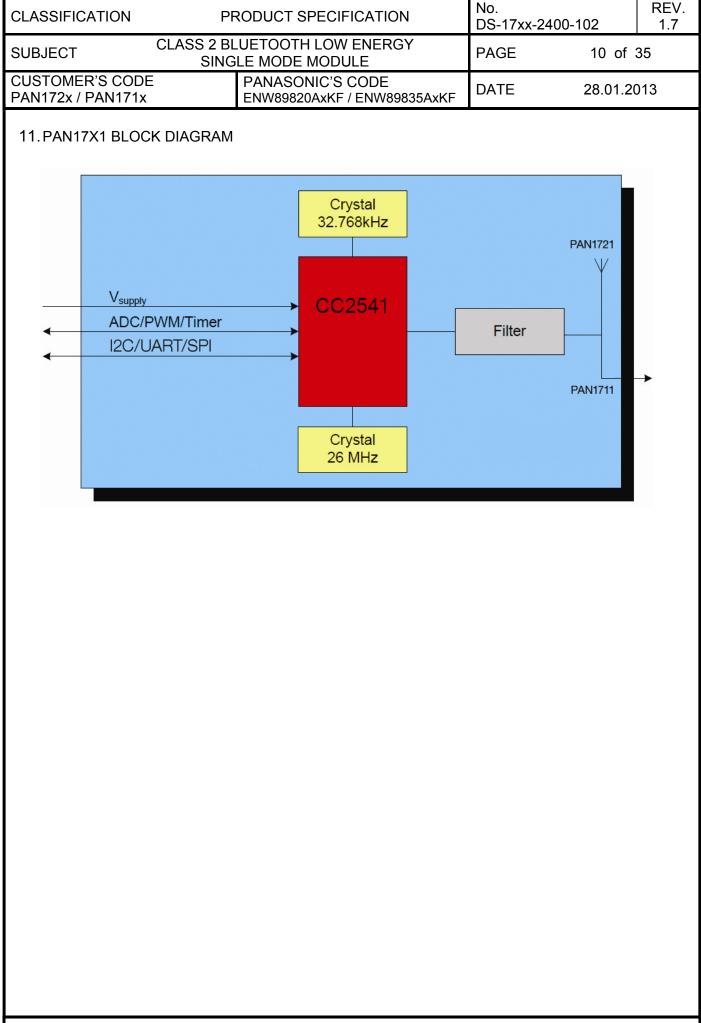
The BlueRadios stack enables rapid and low cost development using an AT command set without the need for a complier. Additional advantages include UART programming, over-the-air-updates, easy integration "C" library framework, serial streaming of data, and smart phone libraries and applications.



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No	Pin Name	Pin Type	Description
A1	GND	Ground Pin	Connect to Ground
A2	P1.0	Digital I/O	Port 1.0 – 20mA drive capability
A3	Reset	Digital Input	Reset, active-low
A4	VCC	Power	2V – 3.6V analog/digital power supply connection
A5	VCC	Power	2V – 3.6V analog/digital power supply connection
A6	VCC	Power	2V – 3.6V analog/digital power supply connection
A7	GND	Ground Pin	Connect to Ground
A8	NC		Not Connected
A9	GND	Ground Pin	Connect to Ground
A11	GND	Ground Pin	Connect to Ground
A12	GND	Ground Pin	Connect to Ground
B1	P1.3	Digital I/O	Port 1.3
B2	P1.2	Digital I/O	Port 1.2
B3	P1.1	Digital I/O	Port 1.1 – 20mA drive capability
B4	P0.6	Digital I/O	Port 0.6
B5	NC		Not Connected
		Disting 1/0	
B6	P0.1 P0.0	Digital I/O	Port 0.1
B7		Digital I/O	Port 0.0
B8	NC		Not Connected
B9	NC		Not Connected
C1	NC		Not Connected
C2	P1.4	Digital I/O	Port 1.4 / BR-SW UART CTS
C3	P1.5	Digital I/O	Port 1.5 / BR-SW UART RTS
C4	P0.7	Digital I/O	Port 0.7
C5	NC		Not Connected
C6	NC		Not Connected
C7	NC		Not Connected
C8	GND	Ground Pin	Connect to Ground
C9	GND	Ground Pin	Connect to Ground
D1	DVDD_USB	Power (digital)	2V – 3.6V digital power supply connection
D2	USB_N	Digital I/O	USB N / PAN17x1 I2C SDA // Leave floating if not used.
D3	USB_P	Digital I/O	USB P / PAN17x1 I2C SCL // Leave floating if not used.
D4	NC _		Not Connected
D5	NC		Not Connected
D6	NC		Not Connected
D7	GND	Ground Pin	Connect to Ground
D8	GND	Ground Pin	Connect to Ground
D9	NC/RF		PAN172x Not Connected/RF_Out PAN171x
E1	P2.1/DD	Digital I/O	Port 2.1 / Programming Interface DD
E2	P2.2/DC	Digital I/O	Port 2.2 / Programming Interface DC
E3	DGND USB	Ground Pin	Connect to Ground
E4	NC		Not Connected
E5	NC		Not Connected
E0 E6	P0.2/RX/MISO	Digital I/O	Port 0.2 / TI-SW UART RX / SPI MISO
E0 E7	NC		Not Connected
		Cround Din	
E8	GND	Ground Pin	Connect to Ground
E9	GND	Ground Pin	Connect to Ground
F1	GND	Ground Pin	Connect to Ground
F2	P1.6	Digital I/O	Port 1.6 / BR-SW UART TX
F3	P1.7	Digital I/O	Port 1.7 / BR-SW UART RX
F4	P2.0	Digital I/O	Port 2.0
F5	P0.4/CTS/CS	Digital I/O	Port 0.4 / TI-SW UART CTS / SPI CS
F6	NC		Not Connected
F7	P0.3/TX/MOSI	Digital I/O	Port 0.3 / TI-SW UART TX /SPI MOSI
F8	P0.5/RTS/CLK	Digital I/O	Port 0.5 / TI-SW UART RTS /SPI CLK
F9	GND	Ground Pin	Connect to Ground
F11	GND	Ground Pin	Connect to Ground
F12	GND	Ground Pin	Connect to Ground

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9. BLUETOOTH FEATURES			
 Class 2 TX power w/o e Excellent link budget (u Accurate digital receive Integrates the new low Embedded BT-Stack av 	ode low energy technology. external PA, improving link robustn ip to 96 dB), enabling long-range a ed signal-strength indicator (RSSI) power profiles and services vailable		
10. PAN1720 BLOCK DIAGRAM			
→ V _{supply} ADC/PWM/Timer UART/SPI/USB	Crystal 32.768kHz CC2540 BT-LE from TI	Filter	
	Crystal 26 MHz	PAN1720	L
Block Diagram of BAN17x1 is sin	nilar but has 120 interface instead of U	SB. Refer to the port page of	
Block Diagram of PAN17x1 is sin to chapter 8.1 PAN172x Terminal	nilar, but has I2C interface instead of U I Layout.	SB. Refer to the next page a	as well as



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12. TEST CONDITIONS

Measurements shall be made under operating free-air temperature range unless otherwise specified.

Temperature	25 ± 10°C
Humidity	40 to 85%RH
Supply Voltage	3.3V

13. GENERAL DEVICE REQUIREMENTS AND OPERATION

All specifications are over temperature and process, unless indicated otherwise.

13.1. ABSOLUTE MAXIMUM RATINGS

No	See ²		Value	Unit			
Rati	Ratings Over Operating Free-Air Temperature Range						
1	Supply voltage	All supply pins must have the same voltage	-0.3 to 3.9	V			
2	Voltage on any o	–0.3 to VDD+0.3 <3,9	V				
3	Operating ambie	nt temperature range	-40 to 85	°C			
4	Storage tempera	-40 to 125	°C				
5	Bluetooth RF inp	puts	10	dBm			
6		ng to human-body model, JEDEC STD 22, method A114 Irged-device model, JEDEC STD 22, method C101	1000 500	v			

13.2. RECOMMENDED OPERATING CONDITIONS

No	Rating	Min	Max	Unit
1	Power supply voltage	2	3.6	V
2	Maximum ambient operating temperature	-40	85	°C

² Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

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13.3. PAN1720 CURRENT CONSUMPTION

The current consumption is dependant on the user scenario and the setup and timing in the low power modes. The total power consumption can be optimized by adjusting the scan windows and intervals.

Please refer for the latest information for different power modes to the chapter "Electrical Characteristics" in Texas Instruments datasheet, refer to [2]. As indication below are typical values from CC2540 datasheet.

For PAN1721 refer to CC2541 datasheet.

ELECTRICAL CHARACTERISTICS

Measured on Texas Instruments CC2540 EM reference design with T_A = 25°C and VDD = 3 V

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
		Power mode 1. Digital regulator on; 16-MHz RCOSC and 32-MHz crystal oscillator off; 32.768-kHz XOSC, POR, BOD and sleep timer active; RAM and register retention		235		
I _{core}	Core current consumption	Power mode 2. Digital regulator off; 16-MHz RCOSC and 32-MHz crystal oscillator off; 32.768-kHz XOSC, POR, and sleep timer active; RAM and register retention	0.9			μA
		Power mode 3. Digital regulator off; no clocks; POR active; RAM and register retention	0.4			
		Low MCU activity: 32-MHz XOSC running. No radio or peripherals. No flash access, no RAM access.		6.7		mA
		Timer 1. Timer running, 32-MHz XOSC used		90		μA
		Timer 2. Timer running, 32-MHz XOSC used		90		μA
	Peripheral current consumption	Timer 3. Timer running, 32-MHz XOSC used		60		μA
Iperi	(Adds to core current I _{core} for each peripheral unit activated)	Timer 4. Timer running, 32-MHz XOSC used		70		μA
	,	Sleep timer, including 32.753-kHz RCOSC		0.6		μA
		ADC, when converting		1.2		mA

GENERAL CHARACTERISTICS

Measured on Texas Instruments CC2540 EM reference design with T_A = 25°C and VDD = 3 V

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
WAKE-UP AND TIMING					
Power mode 1 \rightarrow Active	Digital regulator on, 16-MHz RCOSC and 32-MHz crystal oscillator off. Start-up of 16-MHz RCOSC		4		μs
Power mode 2 or 3 \rightarrow Active	Digital regulator off, 16-MHz RCOSC and 32-MHz crystal oscillator off. Start-up of regulator and 16-MHz RCOSC		μs		
Active \rightarrow TX or RX	Crystal ESR = 16 $\Omega.$ Initially running on 16-MHz RCOSC, with 32-MHz XOSC OFF	410			μs
	With 32-MHz XOSC initially on		160		μs
RX/TX turnaround			150		μs
RADIO PART		•			
RF frequency range	Programmable in 2-MHz steps	2402		2480	MHz
Data rate and modulation format	1 Mbps, GFSK, 250 kHz deviation				

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14. BLUETOOTH RF PERFORMANCE

14.1. PAN1720 BLUETOOTH CHARACTERISTICS

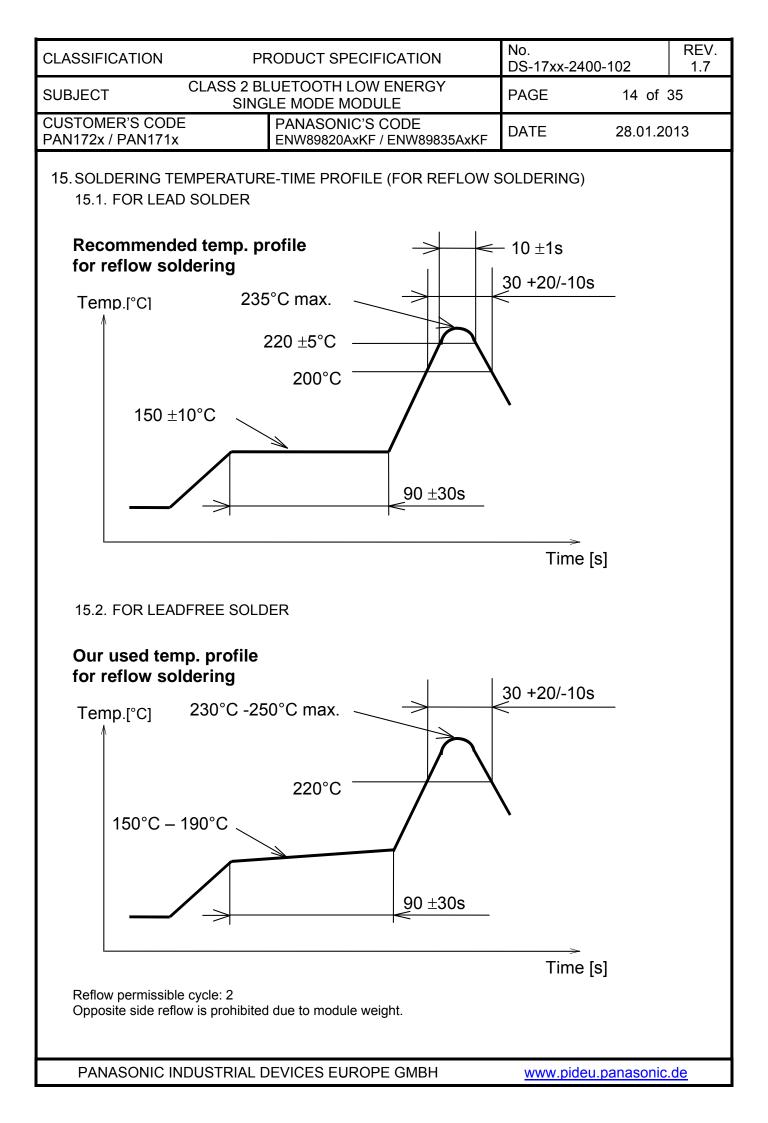
No	Characteristics	Condition	Min	Тур	Max	BT Spec	Unit	
1	Operation frequency range		2402		2480		MHz	
2	Channel spacing			2			MHz	
2	Output Power	Maximum setting, measured at single ended 50ohm.		4			dBm	
3 Output Power	Minimum setting, measured at single ended 50ohm.		-24			dBm		
4	Consitivity Lligh Cain Made	High-gain mode		-93.0		-70	dBm	
4	Sensitivity, High Gain Mode	Standard mode		-92.5		-70	aBm	

14.2. PAN1721 BLUETOOTH CHARACTERISTICS

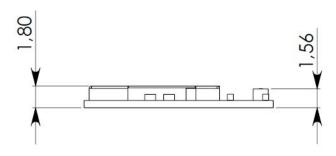
No	Characteristics	Condition	Min	Тур	Max	BT Spec	Unit	
1	Operation frequency range		2402		2480		MHz	
2	Channel spacing			2			MHz	
	Output Power	Maximum setting, measured at single ended 500hm.		0			dBm	
3	3 Output Power	Minimum setting, measured at single ended 500hm.		-24			dBm	
4	Consitivity Lligh Coin Mode	High-gain mode		-93.0		-70	dDm	
4	Sensitivity, High Gain Mode	Standard mode		-92.5		-70	dBm	

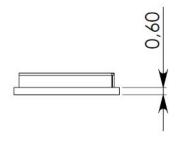
14.3. PAN17XX SPURIOUS EMISSION

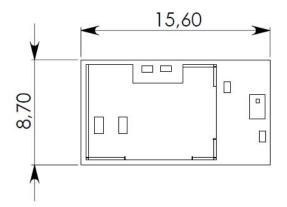
No	Characteristics	Condition	Тур	Max	Unit
1	Spurious emissions	Conducted measurement with a $50-\Omega$ single-ended load. Complies with EN 300 328, EN 300 440 class 2, FCC CFR47, Part 15 and ARIB STD-T-66		-41	dBm

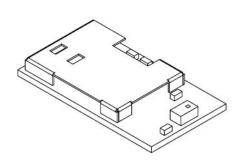


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16. PAN1	72X MODUL	E DIMENS	ION				
No.	No. Item Dimension		Tolerance Remark		¢		
1	Width	8.70		± 0.20			
2	2 Length 15.60)	± 0.20			
3 Height 1.80				±0.20	With case		









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17. PAN1	71X MODULE D	DIMENSION	Tolerance	Remark		
1	Width	8.70	± 0.20			
2	Length	11.60	± 0.20			
3	Height	1.80	± 0.20	With case		
1,8			<u> </u>		3	

(made by Laser)

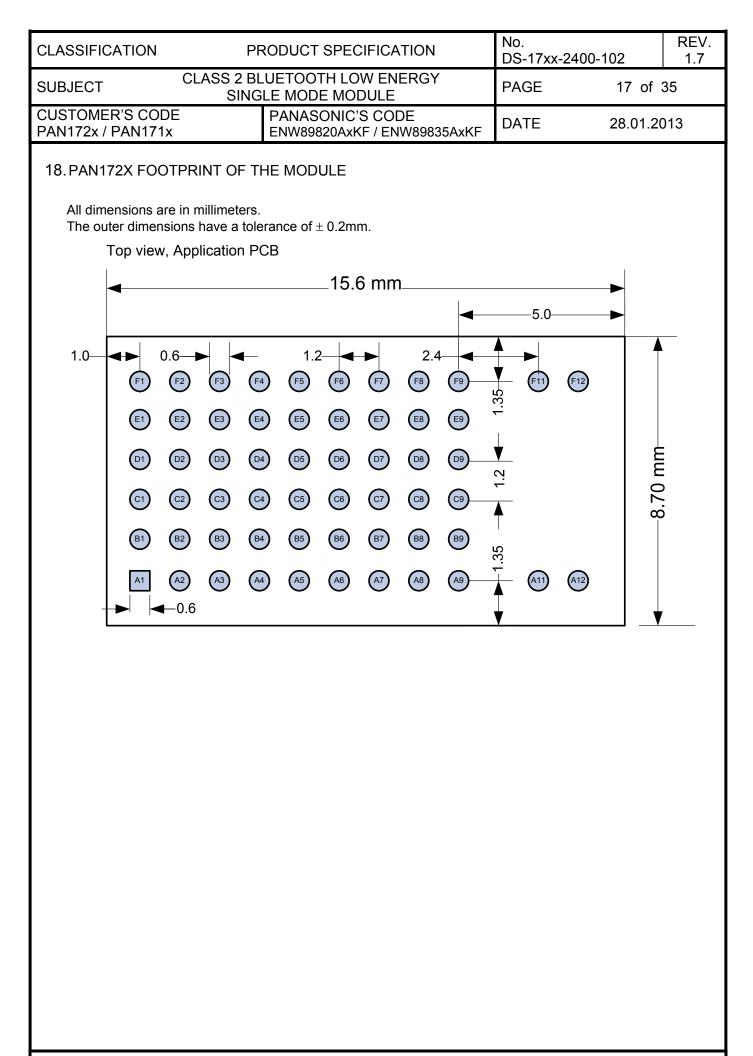
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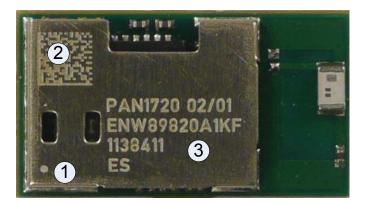
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19. PAN1	71X FO0	OTPRIN	NT OF	THE N	IODUL	.E							
	ensions a iter dimen				e of ± 0).2mm.							
	Top view	/, Appli	cation							l			
◄ 11.6 mm ►													
1.0—	1.0 ◀► 0.6 ► ◀ 1.2 ◀►												
	F1	F 2	F3	F4	F 5	F 6	F7	F8	F 9	1.35-			
	E1	E2	E3	E4	E 5	E6	E7	E8	E 9	-1.			
	D 1	D2	D 3		D5	D6	D7	D 8	D 9	1.2	mm		
	C1	C2	C 3	C 4	C 5	60	C 7	C 8	(3)	-	8.70 mm		
	B1	B2	B3	B4	B5	B6	B7	B8	B9	1.35 —			
	A1	A2	A3	(A4	A5	(A6)	A7	A8	A9				
_		€ —0.6								V	V		

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20. CASE MARKING



No.	Remark
1	Marking for Pin 1 (Circle 0,15 mm)
2	2D-Code, for internal usage only and can be change without any notice
3	Marking definition see below

20.1. EXAMPLE FOR MARKING

Ρ	Α	Ν	1	7	2	0			Η	W	/	S	W		
Е	Ν	W	8	9	8	2	0	Α	Х	Κ	F				
Υ	Υ	W	W	D	L	L									
F	С	С		D	•••		Т	7	V	Ρ	Α	Ν	1	7	

20.2. MARKING DEFINITION

- (1) Pin1 marking
- (2) 2D code (Serial number)
- (3) Marking:
 - PAN17xx (Model Name), HW/SW (Hardware/Software version)
 - ENW89820AxKF (Part Number, refer to chapter 26 Ordering Information)
 - Lot code (YearYear, WeekWeek, Day, LotLot)
 - ES (Engineering Sample marking)

Note: For available Software Versions, refer to [1] PAN172xETU Design-Guide. and chapter 26 Ordering Information.

21. MECHANICAL REQUIREMENTS

No.	Item	Limit	Condition
1	Solderability	More than 75% of the soldering area shall be coated by solder	Reflow soldering with recommendable temperature profile
2	Resistance to soldering heat	It shall be satisfied electrical requirements and not be mechanical damage	See chapter 15.2

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SUBJECT CLASS 2 BLUETOOTH LOW ENERGY SINGLE MODE MODULE			PAGE	20 of 3	35		
CUSTOME PAN172x /		PANASONIC'S CODE ENW89820AxKF / ENW8	9835AxKF	DATE	28.01.20	013	
22. DEVELOPMENT OF APPLICATIONS							
For dev	elopment support plea	se refer to [1] PAN172xETU D	esign-Guide				
23. RELIA	BILITY TESTS						
The me	asurement should be o	done after being exposed to ro	om temperat	ure and humic	lity for 1 hour.		
No. Item Limit Condition							
1 Vibration test Electrical parameter should be in a) 20min. / cycle,1hrs. each of XYZ axis							

1	Vibration test Electrical parameter should be in specification		a) 20min. / cycle,1hrs. each of XYZ axis b) Freq.:30~100Hz, 6G b) 20min. / cycle,1hrs. each of XYZ axis
2	Shock test the same as above I		Dropped onto hard wood from height of 50cm for 3 times
3	Heat cycle test	the same as above	-40°C for 30min. and +85°C for 30min.; each temperature 300 cycles
4	Moisture test	the same as above	+60°C, 90% RH, 300h
5	Low temp. test	the same as above	-40°C, 300h
6	High temp. test	the same as above	+85°C, 300h

24. CAUTIONS

Failure to follow the guidelines set forth in this document may result in degrading of the product's functions and damage to the product.

24.1. DESIGN NOTES

- (1) Follow the conditions written in this specification, especially the control signals of this module.
- (2) The supply voltage has to be free of AC ripple voltage (for example from a battery or a low noise regulator output). For noisy supply voltages, provide a decoupling circuit (for example a ferrite in series connection and a bypass capacitor to ground of at least 47uF directly at the module).
- (3) This product should not be mechanically stressed when installed.
- (4) Keep this product away from heat. Heat is the major cause of decreasing the life of these products.
- (5) Avoid assembly and use of the target equipment in conditions where the products' temperature may exceed the maximum tolerance.
- (6) The supply voltage should not be exceedingly high or reversed. It should not carry noise and/or spikes.
- (7) Keep this product away from other high frequency circuits.

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24.2. INSTALLATION NOTES

- Reflow soldering is possible twice based on the conditions in chapter 15. Set up the temperature at the soldering portion of this product according to this reflow profile.
- (2) Carefully position the products so that their heat will not burn into printed circuit boards or affect the other components that are susceptible to heat.
- (3) Carefully locate these products so that their temperatures will not increase due to the effects of heat generated by neighboring components.
- (4) If a vinyl-covered wire comes into contact with the products, then the cover will melt and generate toxic gas, damaging the insulation. Never allow contact between the cover and these products to occur.
- (5) This product should not be mechanically stressed or vibrated when reflowed.
- (6) To repair the board by hand soldering, follow the conditions set forth in this chapter.
- (7) Do not wash this product.
- (8) Refer to the recommended pattern when designing a board.
- (9) Pressing on parts of the metal cover or fastening objects to the metal will cause damage to the unit.
- (10) For more details on LGA (Land Grid Arrey) soldering processes refer to the application note.

24.3. USAGE CONDITIONS NOTES

- (1) Take measures to protect the unit against static electricity. If pulses or other transient loads (a large load applied in a short time) are applied to the products, check and evaluate their operation befor assembly on the final products.
- (2) Do not use dropped products.
- (3) Do not touch, damage or soil the pins.
- (4) Follow the recommended condition ratings about the power supply applied to this product.
- (5) Electrode peeling strength: Do not add pressure of more than 4.9N when soldered on PCB.
- (6) Pressing on parts of the metal cover or fastening objects to the metal cover will cause damage.
- (7) These products are intended for general purpose and standard use in general electronic equipment, such as home appliances, office equipment, information and communication equipment.

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24.4. STORAGE	NOTES				

- (1) The module should not be stressed mechanically during storage.
- (2) Do not store these products in the following conditions or the performance characteristics of the product, such as RF performance will be adversely affected:
 - Storage in salty air or in an environment with a high concentration of corrosive gas, such as CI2, H2S, NH3, SO2, or NOX
 - Storage in direct sunlight
 - Storage in an environment where the temperature may be outside the range of 5°C to 35°C range, or where the humidity may be outside the 45 to 85% range.
 - Storage of the products for more than one year after the date of delivery Storage period: Please check the adhesive strength of the embossed tape and soldering after 6 months of storage.
- (3) Keep this product away from water, poisonous gas and corrosive gas.
- (4) This product should not be stressed or shocked when transported.
- (5) Follow the specification when stacking packed crates (max. 10).

24.5. SAFETY CAUTIONS

These specifications are intended to preserve the quality assurance of products and individual components.

Before use, check and evaluate the operation when mounted on your products. Abide by these specifications, without deviation when using the products. These products may short-circuit. If electrical shocks, smoke, fire, and/or accidents involving human life are anticipated when a short circuit occurs, then provide the following failsafe functions, as a minimum.

- (1) Ensure the safety of the whole system by installing a protection circuit and a protection device.
- (2) Ensure the safety of the whole system by installing a redundant circuit or another system to prevent a single fault causing an unsafe status.

24.6. OTHER CAUTIONS

- (1) This specification sheet is copyrighted. Please do not disclose it to a third party.
- (2) Please do not use the products for other purposes than those listed.
- (3) Be sure to provide an appropriate fail-safe function on your product to prevent an additional damage that may be caused by the abnormal function or the failure of the product.
- (4) This product has been manufactured without any ozone chemical controlled under the Montreal Protocol.
- (5) These products are not intended for other uses, other than under the special conditions shown below. Before using these products under such special conditions, check their performance and reliability under the said special conditions carefully to determine whether or not they can be used in such a manner.
 - In liquid, such as water, salt water, oil, alkali, or organic solvent, or in places where liquid may splash.
 - In direct sunlight, outdoors, or in a dusty environment
 - In an environment where condensation occurs.
 - In an environment with a high concentration of harmful gas (e.g. salty air, HCl,

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Cl2, SO2, H2S, NH3, and NOX)

(6) If an abnormal voltage is applied due to a problem occurring in other components or circuits, replace these products with new products because they may not be able to provide normal performance even if their electronic characteristics and appearances appear satisfactory.

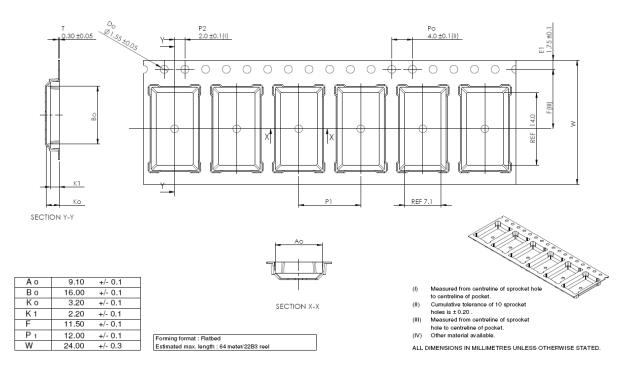
(7) When you have any question or uncertainty, contact Panasonic.

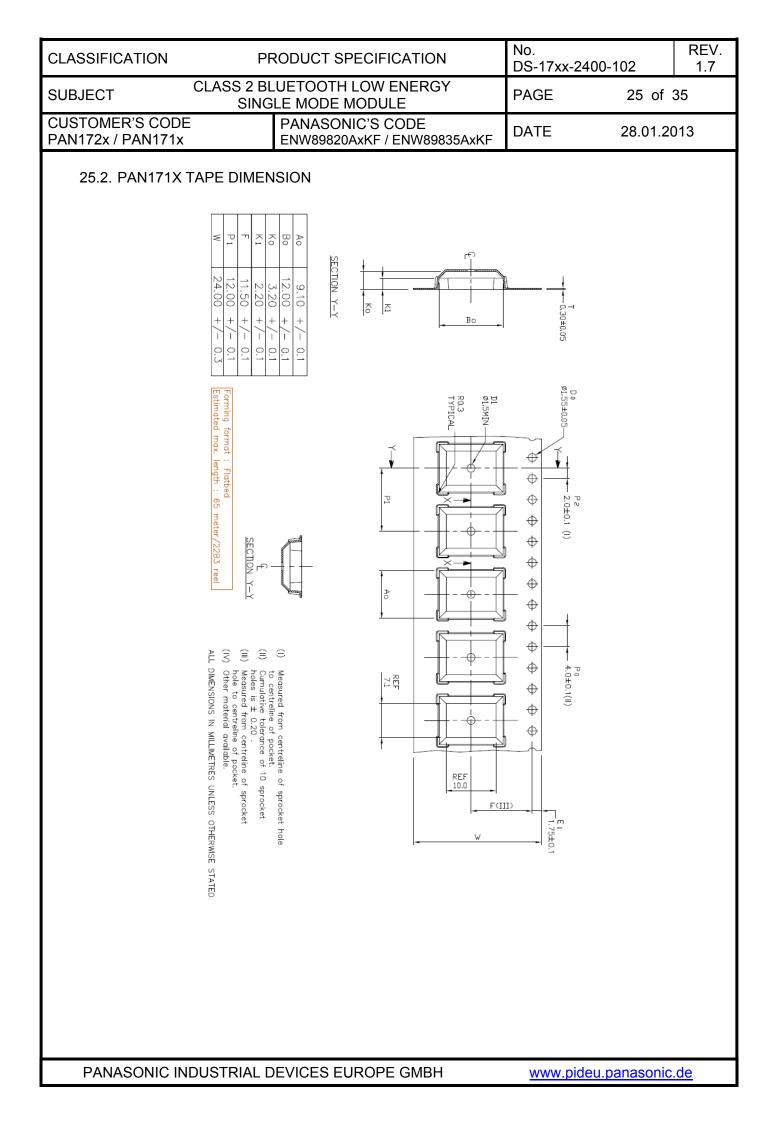
CLASSIFICATION	PF	RODUCT SPECIFICATION	No. DS-17xx-2400	-102	REV. 1.7
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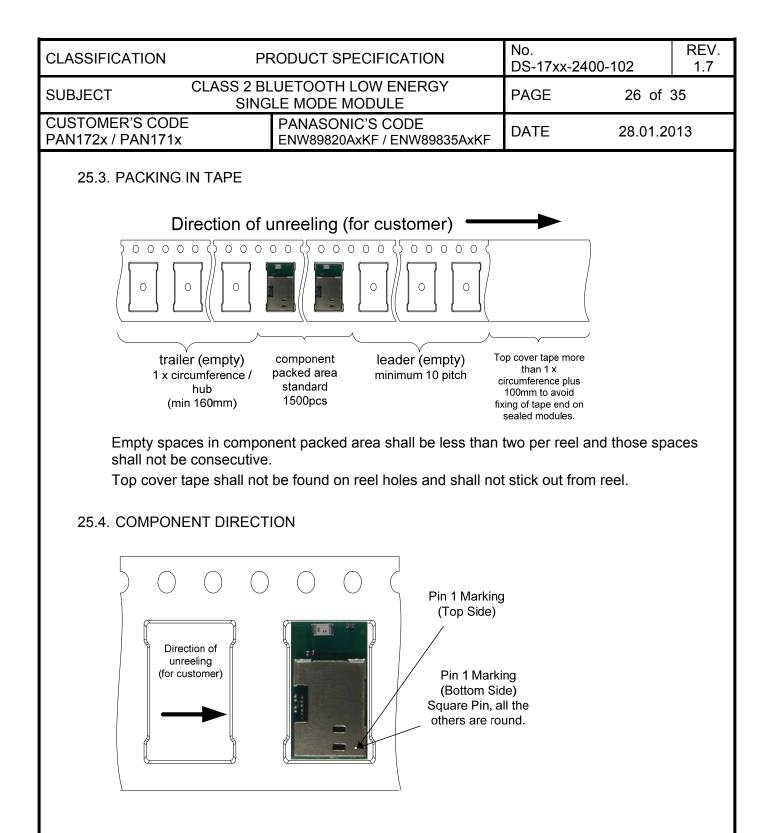
25. PACKAGING

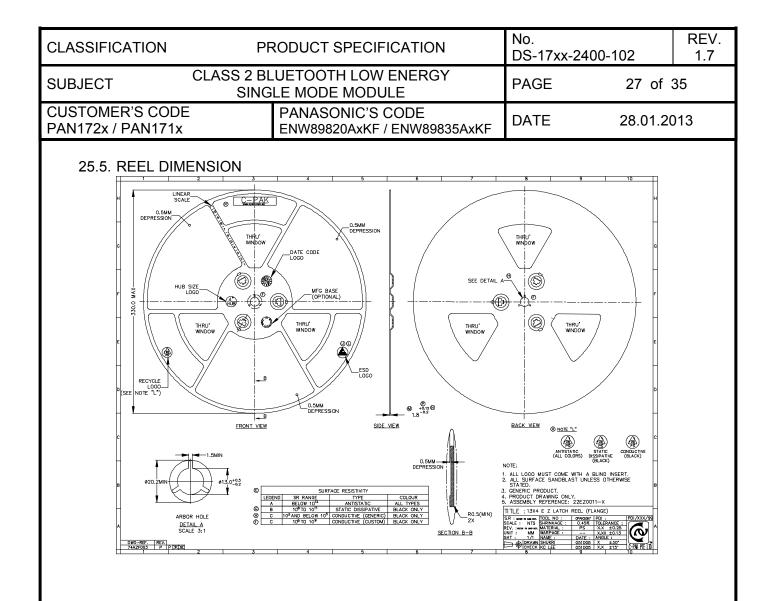
If the product has mass production status, indicated in chapter 28, we will deliver the module in the package which are described below.

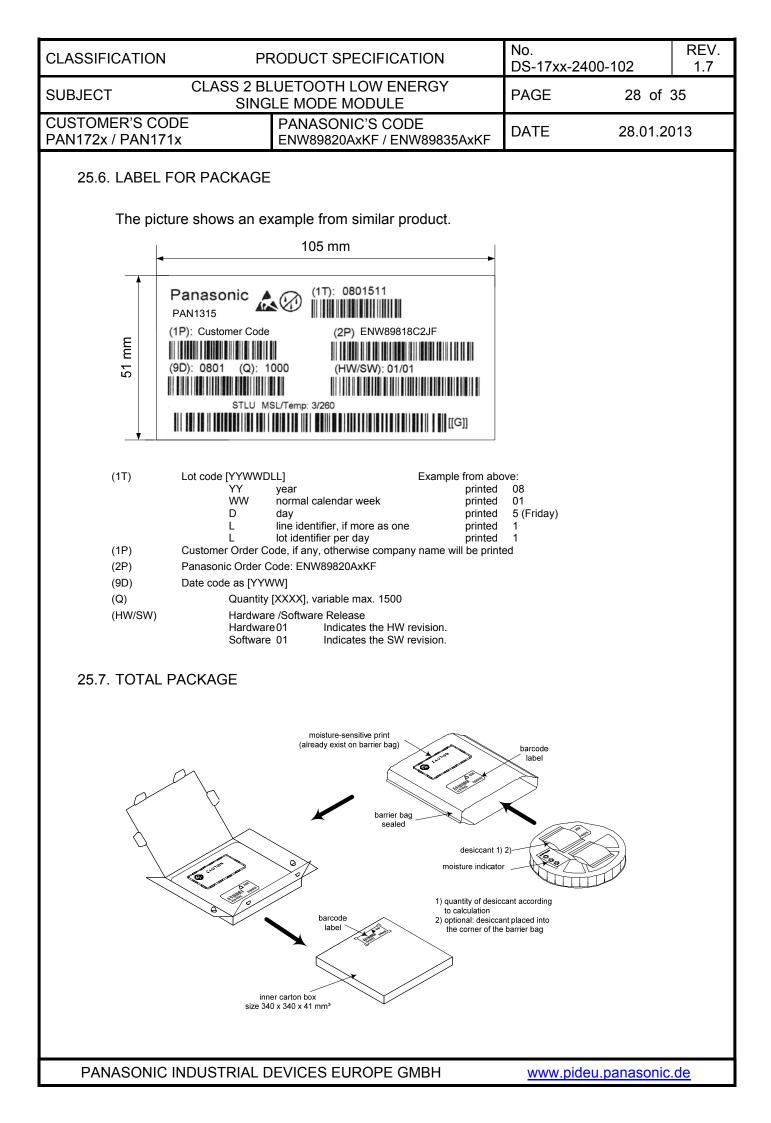
25.1. PAN172X TAPE DIMENSION











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26. ORDERING INFORMATION

Ordering part number	Description	MOQ ⁽¹⁾
	PAN1720	
ENW89820A1KF (2)	CLASS 2 Bluetooth single mode Module according BT-4.0.	1500
	Bluetooth® smart device	
	PAN1720	
ENW89820A3KF (2)	Same as above including BlueRadios BR-SPP FW version.	1500
	Bluetooth® smart device	
	PAN1721	
ENW89835A1KF (2)	CLASS 2 Bluetooth single mode Module according BT-4.0.	1500
	Bluetooth® smart device	
	PAN1721	
ENW89835A3KF ⁽²⁾	Same as above including BlueRadios BR-SPP FW version.	1500
	Bluetooth® smart device	
	PAN1711	
ENW89835C1KF	CLASS 2 Bluetooth single mode Module according BT-4.0.	ES
	Bluetooth® smart device without antenna	
	PAN1711	
ENW89835C3KF	Same as above without antenna including BlueRadios BR-SPP FW version.	ES
	Bluetooth® smart device without antenna	

Notes:

- (1) Abbreviation for Minimum Order Quantity (MOQ). The standard MOQ for mass production is 1500 pieces, fewer only on customer demand. Samples for evaluation can be delivered at any quantity via the distribution channels.
- (2) Samples are available on customer demand

26.1. INFORMATION REGARDING SOFTWARE VERSIONS

ENW89820/35A1KF:

The modules will be delivered with an empty flash. Customers need to program their own TI software in the production process. For details refer to the design guide.

ENW89820/35A3KF:

The modules are delivered with BlueRadios nBlue software. This software includes a bootloader and can be updated over the UART. For the latest revision refer to this link: http://blueradios.com/panasonic/index.php

Note: New customers seeking firmware and firmware support are required to register by providing an invoice number.

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27. ROHS AND REA		-				
Hereby we declare follows th elatest of			ased on declaration of	of our suppliers th	hat this prod	luct
Panasonic Panasonic Industrial I Oravicka 616, 028 01 TR	Devices Slovakia s.r.o RSTENA			145.0		
Tel: +421(0)43 5303 200 Fax: +421(0)43 5303 200						
Dear Customer,			Date: 20	.11.2012		
Panasonic Indu	strial Devices Slov	vakia s.r.o., guarante	ee that:			
Directive 1907/2	2006 (REACH)					
(SVHC) publish our products abo Due to the high	ned by ECHA are not by 0.1% (w/w). complexity of the	regular monitored if ese substance invest	substances of very h f SVHC substances are stigations covering all ill provide you with	e contained in of our global		
information rega	arding our products	s base on informatic	on collected from our s	suppliers.		
Panasonic Indu manufactured an SVHC Substance	nd delivered to you	w <mark>akia s.r.o.</mark> hereby c ar company have SV	declares that all production of the substances < 0.1%	cts % (w/w).		
SVHC Car SVHC Car SVHC Car SVHC Car SVHC Car SVHC Car SVHC Car	ndidate list 1 ndidate list 2 ndidate list 2 ndidate list 3 ndidate list 3 ndidate list 4 ndidate list 5 ndidate list 6 ndidate list 7	(28/10/2008) (13/01/2010) (30/03/2010) (18/06/2010) (15/12/2010) (20/06/2011) (19/12/2011) (18/06/2012)	 [15 Substances] [12 Substances] [1 Substance] [8 Substances] [8 Substances] [7 Substances] [20 Substances] [13 Substances] 			
Directive 2011/0	65/EC (RoHS)					
following substa maximum conce - Lead and - Mercury - Chromiu - PBB (pol	ances which are ba entration of 0.1% b d lead compounds, y and mercury compou um (VI), olybrominated biphenyl	anned by Directive by weight in homoge ands, (1) category, PBDE (pol)	luding package do no 2002/95/EC (RoHS) (eneous materials for: lybrominated hiphenyl ethe omogeneous materials for:	or if contain a er) category		

- Cadmium and cadmium compounds.

Wireless Modules (ENW898series; ENW596series; ENWC9Aseries)

Create:	Kostalikova Alena	Check:	Firmentova Viera	Approval:	Kashiwaya Shinichi
EQ	fora 41	QA&QC	FA	Managing Director	& Kashiwyn

For the most updated one, please refer to [4].

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28. DATA SHEET STATUS

This data sheet contains the final specification (RELEASE).

Panasonic reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

Please consult the most recently issued data sheet before initiating or completing a design.

Use this URL to search for the most recent version of this data sheet: Use this URL to search for the most recent version of this data sheet:

PAN172x Datasheet

29. HISTORY FOR THIS DOCUMENT

Revision	Date	Modification / Remarks
0.01	November 2011	1 st preliminary version.
0.02	November 2011	Deleted footnote in chapter 13.
1.00	April 2012	Released Version.
1.1	July 2012	Add chapter 26.1 Information regarding Software Versions. Link to LGA app note. Removed watermark. UART pinning for BR-SW version. I2C pinning for PAN1721 version. FCC, IC, IDs.
1.2	July 2012	Added remark "top view" for footprint. Corrected FCC ID to T7VPAN17. Change to the correct company name in footer.
1.3	Agust 2012	Change IC text in chapter 33.1 Change to the correct company name in footer. New format for chapter Related Documents
1.4	November 2012	Added some remarks to PAN1721 version. Added non antenna version part number to Ordering information.
1.5	December 2012	Added PAN1711 ES information
1.6	January 2013	Added dimensions and pinout for the non-antenna versions PAN171x.
1.7	January 2013	Minor changes in chapter 6, 31.4. Chapter 3 was included and chapter 34 BT Certificiation was added.

30. RELATED DOCUMENTS

For an update, please search in the suitable homepage.

- [1] PAN172xETU Design-Guide http://www.pideu.panasonic.de/pdf/168ApplicationNote.pdf
- [2] Semiconductor Datasheet <u>CC2540 from Texas Instruments</u> <u>CC2541 from Texas Instruments</u>
- [3] Application Note Land Grid Array http://www.pideu.panasonic.de/pdf/184ext.pdf
- [4] REACH and RoHS Certificate http://www.pideu.panasonic.de/pdf/182ext2.jpg
- [5]

www.pideu.panasonic.de

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31. GENERAL INFORMATION

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All rights reserved.

This product description does not lodge the claim to be complete and free of mistakes. Please contact the related product manager in every case.

If we deliver ES samples to the customer, these samples have the status Engineering Samples. This means, the design of this product is not yet concluded. Engineering Samples may be partially or fully functional, and there may be differences to be published Data Sheet. Engineering Samples are not qualified and are not to be used for reliability testing or series production.

Disclaimer:

Customer acknowledges that samples may deviate from the Data Sheet and may bear defects due to their status of development and the lack of qualification mentioned above.

Panasonic rejects any liability or product warranty for Engineering Samples. In particular, Panasonic disclaims liability for damages caused by

- the use of the Engineering Sample other than for Evaluation Purposes, particularly the installation or integration in an other product to be sold by Customer,
- deviation or lapse in function of Engineering Sample,
- improper use of Engineering Samples.

Panasonic disclaimes any liability for consequential and incidental damages.

In case of any questions, please contact your local sales partner or the related product manager.

32. REGULATORY INFORMATION

32.1. FCC NOTICE



The devices PAN17xx, for details refer to Chapter 26, including the antennas, which are listed in 32.5, complies with Part 15 of the FCC Rules. The device meets the requirements for modular transmitter approval as detailed in FCC public Notice DA00-1407.transmitter Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) This device must accept any interference received, including interference that may cause undesired operation.

32.2. CAUTION



The FCC requires the user to be notified that any changes or modifications made to this device that are not expressly approved by Panasonic Industrial Devices Europe GmbH may void the user's authority to operate the equipment.

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

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- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help

32.3. LABELING REQUIREMENTS



The Original Equipment Manufacturer (OEM) must ensure that FCC labeling requirements are met. This includes a clearly visible label on the outside of the OEM enclosure specifying the appropriate Panasonic FCC identifier for this product as well as the FCC Notice above. The FCC identifier are **FCC ID: T7VPAN17**. This FCC identifier is valid for all PAN17xx modules, for details, see the Chapter 26. Ordering Information.

In any case the end product must be labelled exterior with "Contains FCC ID: T7VPAN17"

32.4. ANTENNA WARNING

For the related part number of PAN17xx refer to Chapter 26. Ordering Information.

This devices are tested with a standard SMA connector and with the antennas listed below. When integrated in the OEMs product, these fixed antennas require installation preventing end-users from replacing them with non-approved antennas. Any antenna not in the following table must be tested to comply with FCC Section 15.203 for unique antenna connectors and Section 15.247 for emissions. The FCC identifier for this device with the antenna listed in item 1 are the same (FCC ID: T7VPAN17).

32.5. APPROVED ANTENNA LIST

Note: We are able to qualify your antenna and will add to this list as that process is completed.

Item	Part Number	Manufacturer	Frequency Band	Туре	Gain (dBi)
2	LDA212G3110K	Murata	2.4GHz	Chip-Antenna	+0.9

32.6. RF EXPOSURE PAN17XX



To comply with FCC RF Exposure requirements, the Original Equipment Manufacturer (OEM) must ensure that the approved antenna in the previous table must be installed.

The preceding statement must be included as a CAUTION statement in manuals for products operating with the approved antennas in the previous table to alert users on FCC RF Exposure compliance.

Any notification to the end user of installation or removal instructions about the integrated radio module is not allowed.

The radiated output power of PAN17xx with mounted ceramic antenna **(FCC ID: T7VPAN17)** is far below the FCC radio frequency exposure limits. Nevertheless, the PAN17xx shall be used in such a manner that the potential for human contact during normal operation is minimized.

End users may not be provided with the module installation instructions. OEM integrators and end users must be provided with transmitter operating conditions for satisfying RF exposure compliance.

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33. IND	USTRY CANAD	A CERTIFICATIO	ON				
	license: IC: 210 Manufacturers clarify any reg Users can obta This device ha a maximum ga	ensed to meet th 6Q-PAN17 of mobile, fixed ulatory questions ain Canadian info s been designed in of 0.9 dBi. Ant y prohibited for u	or portable de s and ensure c ormation on RF to operate with cennas not inclu	vices incorpol ompliance for exposure and the antennas ded in this list	rating this m SAR and/o compliance s listed in Ta or having a	nodule are ad r RF exposur from <u>www.ic.</u> able 20 above gain greater	e limits. <u>gc.ca</u> . , having than 0.9
	ohms. The an conjunction wit Due to the mo	thenna used for the any other ante del size the IC ic ed on the module	r this transmit nna or transmit lentifier is displa	ter must not er. ayed in the in:	be co-loca	ated or operative	ating in
33.1.	in 32.5, comp modular Operation is s	AN17xx, for deta lies with Canada transmitter ubject to the follo and (2) This o that	a RSS-GEN R approval owing two cond	ules. The de as d litions: (1) Th	vice meets etailed is device ma	the requirem in RS ay not cause received, ir	ents for S-GEN. harmful
33.2.	The Original E met. This inclu appropriate Pa identifier is 210 the Chapter 26		ible label on th tifier for this pr IC identifier is	e outside of t oduct as well valid for all P.	he OEM end as the IC N	closure specif Notice above. dules, for deta	ying the The IC ails, see
34.BLU	ETOOTH CERT	TIFICATION					
	•	listed as Controll etooth.org/tpg/EPL	•		16552		
	The module is	listed as EPL ba	ased on Texas I	nstruments Q	DID B01655	2.	
	To create an E need to be co	EPL, two Subsyst mbined.	tems e.g. QDID	: B016552 an	d QDID: B01	17183 (softwa	re stack)

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35. EUROPEAN R&TTE DECLARATION OF CONFORMITY

Hereby, Panasonic Industrial Devices Europe GmbH, declares that the Bluetooth module PAN17xx and their versions is in compliance with the essential requirements and other relevant provisions of Directive 1999/5/EC. As a result of the conformity assessment procedure described in Annex III of the Directive 1999/5/EC, the end-customer equipment should be labelled as follows:

C€

PAN17xx and their versions in the specified reference design can be used in the following countries: Austria, Belgium, Cyprus, Czech Republic, Denmark, Estonia, Finland, France, Germany, Greece, Hungary, Ireland, Italy, Latvia, Lithuania, Luxembourg, Malta, Poland, Portugal, Slovakia, Slovenia, Spain, Sweden, The Netherlands, the United Kingdom, Switzerland, and Norway.

36. LIFE SUPPORT POLICY

This Panasonic product is not designed for use in life support appliances, devices, or systems where malfunction can reasonably be expected to result in a significant personal injury to the user, or as a critical component in any life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness. Panasonic customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Panasonic for any damages resulting.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Bluetooth Development Tools - 802.15.1 category:

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